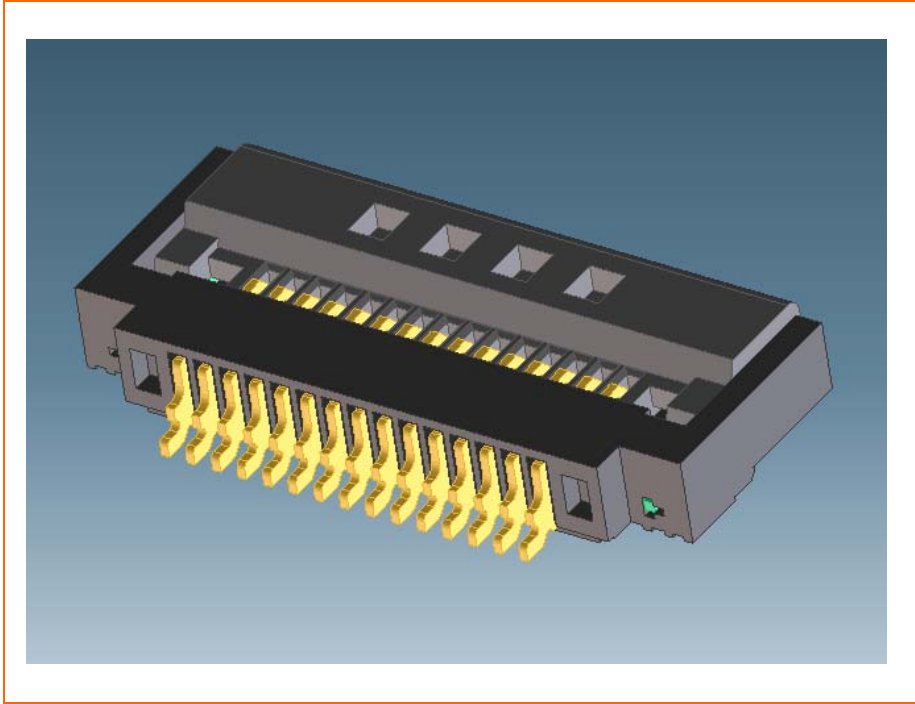


**Product Specification**



深圳市臺華達科技有限公司

SHENZHENSHI THD Electronics Co., Ltd.



Product.No

**THD05175 – xxCL – GF**

**Pitch=0.50mm,H=1.75 mm FPC Connector (Front-Flip Lower Contact)**

A	Release
Rev.	Description

**Approved Signatures**

■Prepared By : JIM	■Date: 2012.05.24
■Checked By : JIM	■Date: 2012.05.24
■Approved By : 黄德进	■Date: 2012.05.24

## ■ Scope

This specification covers the 0.5 mm Pitch FPC Connector **THD05175** series.

## ■ Ordering information

THD05175 - xx CL - GF

①                      ②                      ③                      ④

①	Series name : <b>THD05175</b>	④	Plating : GF= 1μ"~3μ" Gold Flash G3= 3μ" Gold over Nickel G5= 5μ" Gold over Nickel SN= Tin(Lead Free) over Nickel
②	Number of contacts : 6 TO 60		
③	Contact type : CL:Lower contact CU:Upper contact		

## ■ Rating

Item	Standard
Voltage Rating(Max.)	50V AC
Current Rating(Max.)	0.3A DC
Operating Temperature Range	-55°C ~ +85°C (Including terminal temperature rise)

## ■ Material

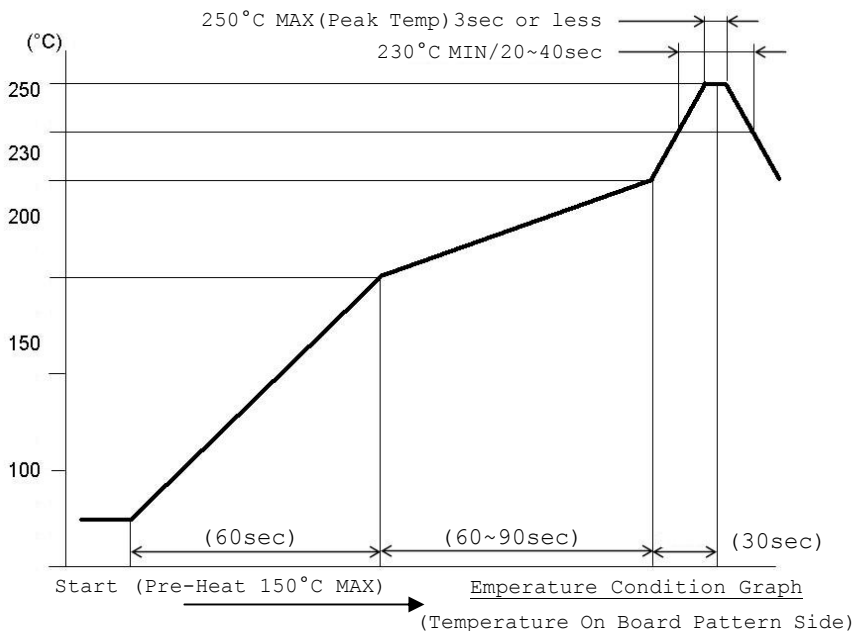
Housing	Actuator	Terminal	Solder pin	Plating
L.C.P (UL94V-0)	L.C.P (UL94V-0)	Copper alloy	Copper alloy	1μ"~3μ" Gold over Nickel
Color : Black	Color : Black			

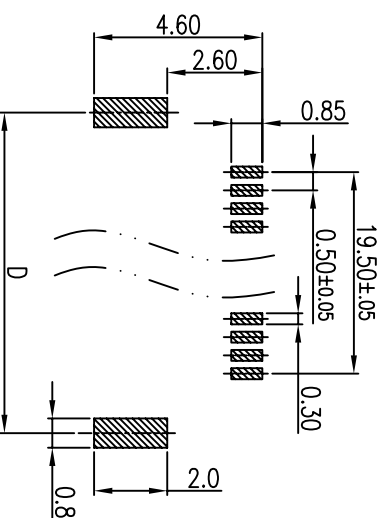
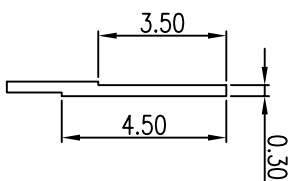
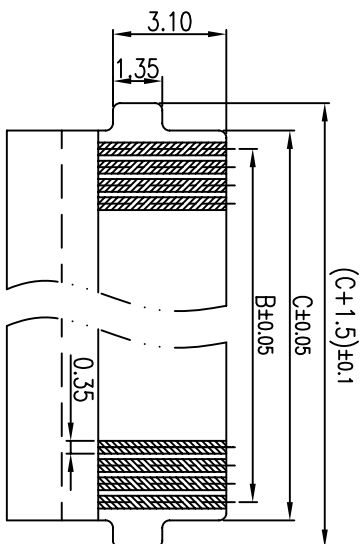
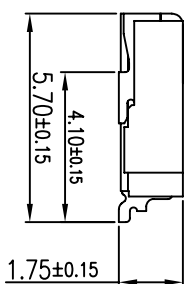
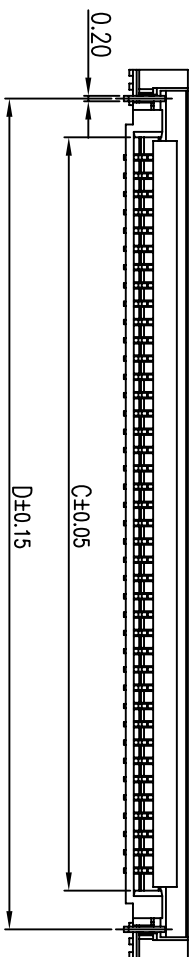
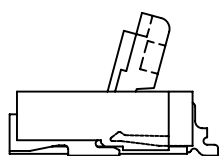
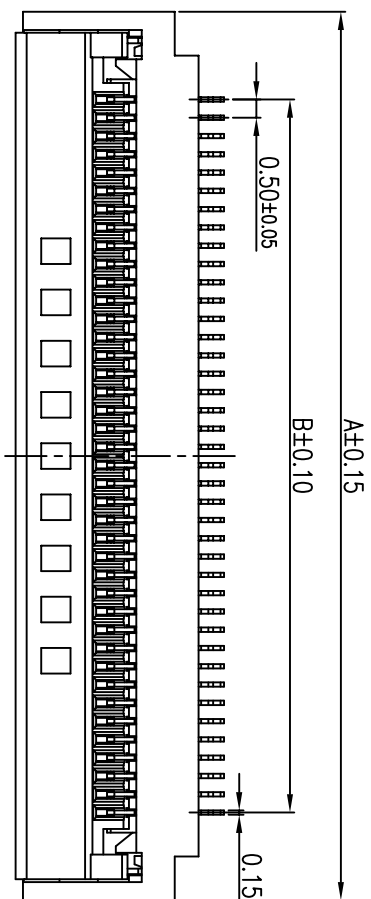
## ■ Performance

Item	Test Condition	Specification	
Contact Resistance	Mate applicable FPC and measure by dry circuit, 20mV Max, 1mA.	30 mΩ Max.	
Insulation Resistance	Mate applicable FPC and apply 500V DC between adjacent terminal or ground.	500 MΩ Min.	
Dielectric Strength	Mate applicable FPC, apply 250V AC(rms) for 1 minute between adjacent terminal or ground.	No Breakdown	
FPC Retention Force	Insert the actuator, pull the FPC at a rate of 25±3mm per minute.	Per pin x 0.3N Min.	
Terminal Retention Force	Apply axial pull out force at the rate of 25±3 mm/minute on the terminal assembled in the housing.	Per pin x 0.05Kgf {0.5N} Min.	
Vibration	Mate connectors and subject to the following vibration conditions, for period of 2 hours in each of 3 mutually perpendicular axes, passing DC 1mA during the test.  Amplitude : 1.5mm P-P Frequency : 10~55~10 Hz in 1 minute. Duration : 2 hours in each of X,Y,Z axes.	Appearance	No Damage
		Contact Resistance	50 mΩ Max.
		Discontinuity	1 μsec Max.
Shock	Mate applicable FPC and subject to the following shock conditions. 3 times of shocks shall be applied for each 6 directions along 3 mutually perpendicular axes, passing DC 1 mA current during the test.  Peak value : 490m/s <sup>2</sup> {50G}	Appearance	No Damage
		Contact Resistance	50 mΩ Max.
		Discontinuity	1 μsec Max.
Salt Spray	Mate applicable FPC and expose to the following salt mist conditions. Upon completion of the exposure period, salt deposits shall be removed by a gentle wash or dip in running water, after which the specified measurements shall be performed.  NaCl solution Concentration : 5 ± 1% Spray time : 48 ± 4 hours Ambient temperature : 35 ± 2°C	Appearance	No Damage
		Contact Resistance	50 mΩ Max.

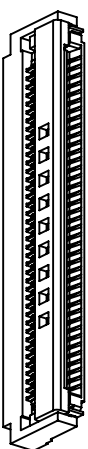
Item	Test Condition	Specification	
Heat Resistance	Mate applicable FPC and expose to 85±2°C for 96 hours. Upon completion of the exposure period, the test specimens shall be conditioned at ambient room conditions for 1 to 2 hours, after which the specified measurements shall be performed.	Appearance	No Damage
		Contact Resistance	50 mΩ Max.
Cold Resistance	Mate applicable FPC and expose to -40±2°C for 96 hours. Upon completion of the exposure period, the test specimens shall be conditioned at ambient room conditions for 1 to 2 hours, after which the specified measurements shall be performed.	Appearance	No Damage
		Contact Resistance	50 mΩ Max.
Humidity	Mate applicable FPC and expose to 60 ± 2°C, relative humidity 90 to 95% for 96 hours. Upon completion of the exposure period, the test specimens shall be conditioned at ambient room conditions for 1 to 2 hours, after which the specified measurements shall be performed.	Appearance	No Damage
		Contact Resistance	50 mΩ Max.
		Dielectric Strength	No Breakdown
		Insulation Resistance	100 MΩ Min.
Temperature Rise	Mate applicable FPC and measure the temperature rise of contact when the maximum AC rated current is passed.	Temperature rise	30°C Max.
Temperature Cycling	Mate applicable FPC and subject to the following conditions for 5 cycles. Upon completion of the exposure period, the test specimens shall be conditioned at ambient room conditions for 1 to 2 hours, after which the specified measurements shall be performed. 1 cycle a) -55±3°C      30minutes b) +85±3°C      30minutes (Transit time shall be with in 3 minutes)	Appearance	No Damage
		Contact Resistance	50 mΩ Max.
Solderability	Tip of solder tails and fitting nails into the molten solder (held at 245±5°C) up to 0.1mm from the bottom of the housing for 3±0.5 seconds.	Solder Wetting	95% of immersed area must show no voids, pin holes.
Resistance to Soldering	When reflowing refer to Infrared reflow condition <u>Soldering iron method</u> 0.2mm from terminal tip and fitting nail tip. Soldering time : 5 seconds Max. Solder temperature : 370~400°C	Appearance	No Damage

### ■ Recommended Temperature Profile





RECOMMENDED FPC DIMENSION



1. MATERIAL  
HOUSING: LCP UL 94V-0  
ACTUATOR: LCP UL 94V-0  
CONTACTS: COPPER ALLOY  
PEG: COPPER ALLOY
2. PLATING:  
CONTACTS: TIN OVER NICKEL  
PEG: TIN OVER NICKEL
3. PART NO:  
OPERATING VOLTAGE: 50V AC, DC  
CURRENT RATING: 0.3A AC, DC  
OPERATING TEMPERATURE: -25°C ~ +85°C
4. PART NO:

THD05175-XXCL-XX  
 GF: GOLD FLASH  
 SN: TIN OVER NICKEL  
 NO. OF CONTACTS: (08Pin~60Pin)

No. of Contacts	DIM.			
	A	B	C	D
06	7.30	2.50	3.60	5.72
08	8.30	3.50	4.60	6.72
10	9.30	4.50	5.60	7.72
12	10.30	5.50	6.60	8.72
13	10.80	6.00	7.10	9.22
15	11.80	7.00	8.10	10.22
18	13.30	8.50	9.60	11.72
24	16.30	11.50	12.60	14.72
28	18.30	13.50	14.60	16.72
30	19.30	14.50	15.60	17.72
40	24.30	19.50	20.60	22.72
50	29.30	24.50	25.60	27.72
57	32.80	28.00	29.10	28.22
60	34.30	29.50	30.60	29.72

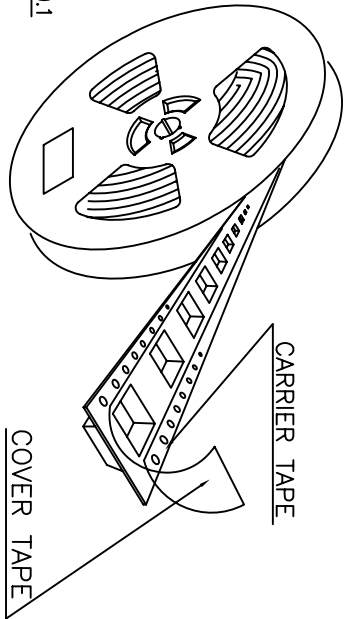
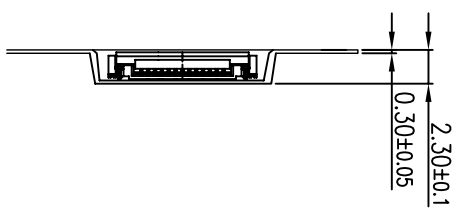
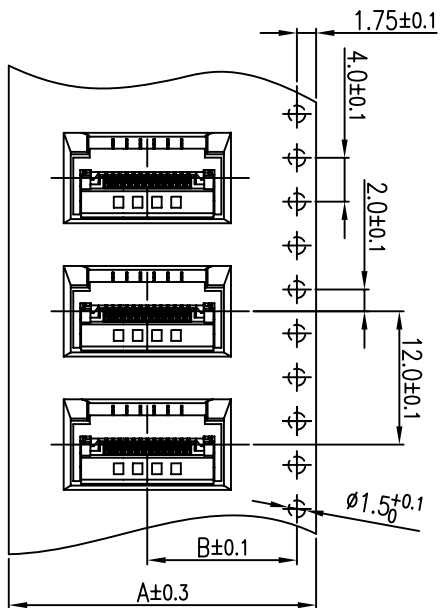
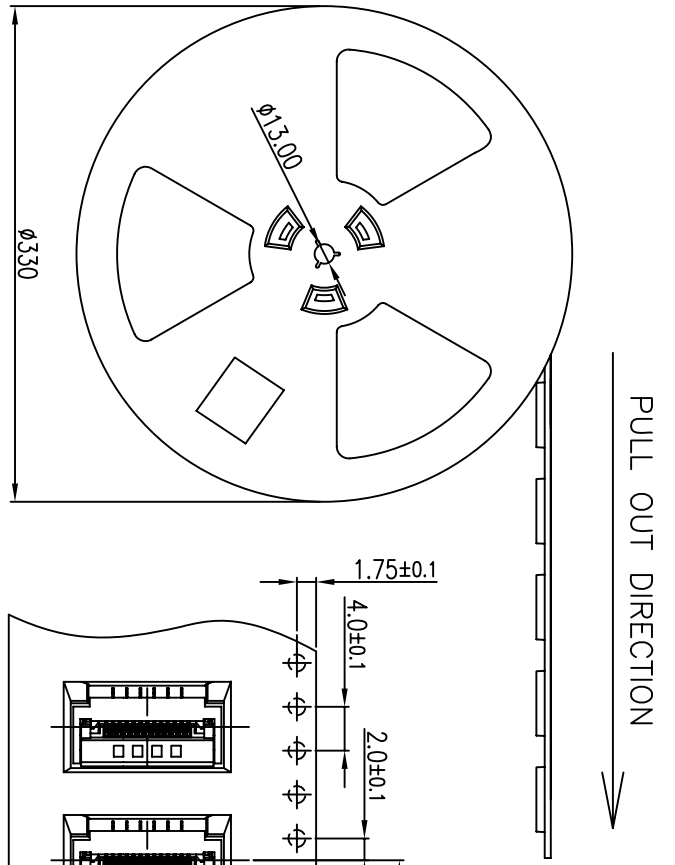
REV.	REVISIONS	CHK	DATE
X2	Prototype	JJM	2018/09/15
X1	Initial	JJM	2018/09/10

**THD ELECTRONICS**  
 深圳市壹華達科技有限公司  
 SHENZHENSHI THD ELECTRONICS CO., LTD.

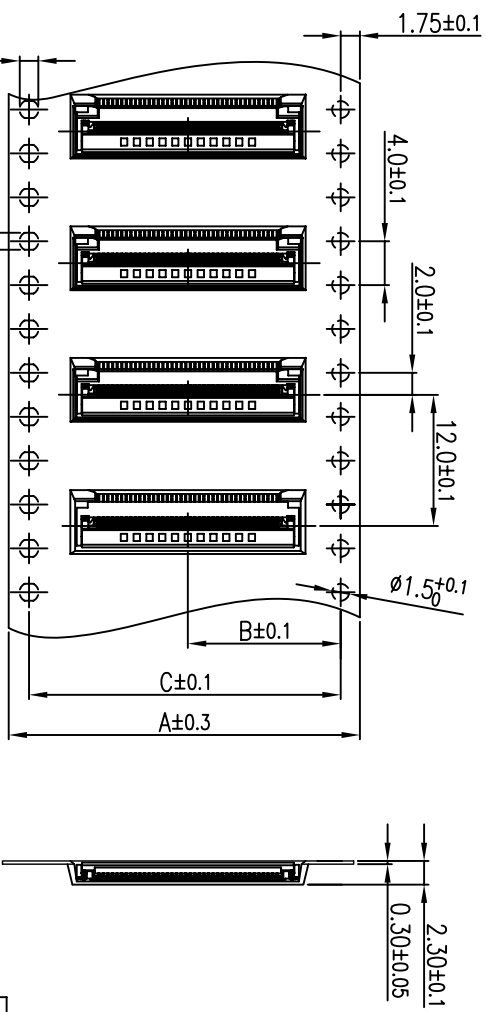
GENERAL TOLERANCE: **JJM 2018.03.10**  
 UNLESS OTHERWISE SPECIFIED  
 XX ±0.35  
 XXX ±0.25  
 XXXX ±0.15  
 ANG. ±3°

DRAWN: **JJM 2018.03.10**  
 CHECKED: **JJM 2018.03.10**  
 APPROVED: **2018.03.10**  
 SHEET: 1/1


PART NO.: **THD05175-XXCL-XX**  
 TITLE: **0.5 PITCH 1.75H FPC CONN.**  
 UNIT: MM  
 SCALE: 1:1  
 SIZE: A4  
 REV: X2



- Notes:
1. Packing Conforms EIA-481-C Standards.
  2. 10 sprocket hole pitch cumulative  $\pm 0.20\text{mm}$ .
  3. Carrier camber is within 1mm in 250mm.
  4. Material: Black Conductive Polystyrene Alloy.
  5. Packing length per 13" reel: 30.0 Meters.
  6. Component load per 13" reel: 2000 Pcs



Part NO.	Dimension		
	A	B	C
THD05175-60CL	56.00	20.25	40.50
THD05175-32CL~50CL	44.00	20.25	40.50
THD05175-22CL~30CL	32.00	14.25	28.50
THD05175-5CL~20CL	24.00	11.50	
THD05175-4CL	16.00	7.50	


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 SHENZHENSHI THD ELECTRONICS CO., LTD.

REV.	XI	ProtoType	JIM	2018/03/10
REVISIONS			CHK	DATE
GENERAL TOLERANCE DRAWN <i>jtm</i> 2018.03.10 UNLESS OTHERWISE SPECIFIED CHECKED <i>jtm</i> 2018.03.10 XX ±0.35 XXX ±0.25 XXXX ±0.15 ANG. ±3°				
PART NO.		THD05175-XXCL-XX		
TITLE:		0.5 PITCH 1.75H FPC CONN.		
APPROVED		2018.03.10		
SHEET		1/1		
UNIT	MM	SCALE	1:1	SIZE
REV	X1	SIZE	A4	REV